PATENT ASSIGNMENT COVER SHEET

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
MR JUN HU	10/02/2018
MR FEI WANG	10/02/2018
MR MENGYU PAN	10/02/2018
MR ZHIYUN LUO	10/02/2018

RECEIVING PARTY DATA

Name:	HUNTECK SEMICONDUCTOR (SHANGHAI), LTD.	
Street Address:	560 SHENGXIA ROAD	
Internal Address:	SUITE 920C-7	
City:	SHANGHAI	
State/Country:	CHINA	
Postal Code:	201210	

PROPERTY NUMBERS Total: 2

Property Type	Number
Patent Number:	10038089
Application Number:	16048285

CORRESPONDENCE DATA

Fax Number:

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 6509490418
Email: boinlin@gmail.com

Correspondent Name: BO-IN LIN

Address Line 1: 13445 MANDOLI DRIVE

Address Line 4: LOS ALTOS HILLS, CALIFORNIA 94022

ATTORNEY DOCKET NUMBER: HTC-1501

NAME OF SUBMITTER: BO-IN LIN

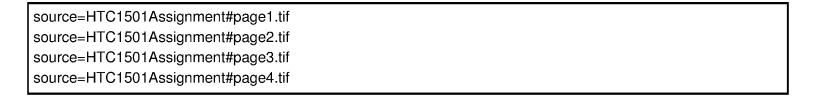
SIGNATURE: /Bo-In Lin/

DATE SIGNED: 11/08/2018

Total Attachments: 4

PATENT REEL: 047457 FRAME: 0086

505182601



PATENT REEL: 047457 FRAME: 0087

INVENTOR

Whereas, I, Jun Hu of 781 Acacia Avenue

AND CITY

San Bruno, California 94066

have invented:

TITLE:

SGT MOSFET WITH ADJUSTABLE CRSS AND CISS

DATE INVENTOR and executed a United States patent application therefor SIGNED THE

DECLARATION on October \$2, 2015;

Whereas, Hunteck Semiconductor (Shanghai), Ltd., a Chinese Company, having its registered address at 560 Shengxia Road Suit 902C-7, Shanghai, China 201210 (hereinafter called HUNTECK), desires to acquire the entire right, title and interest of said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, I, the above named, hereby sell, assign, and transfer to HUNTECK, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing said United States application, and I request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to HUNTECK its successors and assigns; and I hereby agree that HUNTECK may apply for foreign Letters Patent on said invention and I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by

CITY AND

Signed and Sealed at San Bruno, California

DATE

on October 2, 2018.

SIGNATURE OF INVENTOR

PATENT REEL: 047457 FRAME: 0088

INVENTOR AND CITY

Whereas, I, Fei Wang of 1473 Shaffer Drive

San Jose, California 95132

have invented:

TITLE:

SGT MOSFET WITH ADJUSTABLE CRSS AND CISS

DATE INVENTOR and executed a United States patent application therefor

SIGNED THE

DECLARATION on October 22, 2015;

> Whereas, Hunteck Semiconductor (Shanghai), Ltd., a Chinese Company, having its registered address at 560 Shengxia Road Suit 902C-7, Shanghai, China 201210 (hereinafter called HUNTECK), desires to acquire the entire right, title and interest of said application and invention, and to any United States and foreign patents to be obtained therefor:

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CITY AND

Signed and Sealed at San Jose, California

DATE

on October 2, 2018.

SIGNATURE OF INVENTOR

INVENTOR

Whereas, I, Mengyu Pan of Suit 22-2021, 368 Zhangjiang Road

AND CITY

Shanghai, China 201203

have invented:

TITLE:

SGT MOSFET WITH ADJUSTABLE CRSS AND CISS

DATE INVENTOR and executed a United States patent application therefor

SIGNED THE

DECLARATION on October 22, 2015;

Whereas, Hunteck Semiconductor (Shanghai), Ltd., a Chinese Company, having its registered address at 560 Shengxia Road Suit 902C-7, Shanghai, China 201210 (hereinafter called HUNTECK), desires to acquire the entire right, title and interest of said application and invention, and to any United States and foreign patents to be obtained therefor;

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, I, the above named, hereby sell, assign, and transfer to HUNTECK, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing said United States application, and I request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to HUNTECK its successors and assigns; and I hereby agree that HUNTECK may apply for foreign Letters Patent on said invention and I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by

Mengyn Pan

CITY AND

Signed and Sealed at San Jose, California

DATE

on October 2, 2018.

SIGNATURE OF INVENTOR

PATENT REEL: 047457 FRAME: 0090

INVENTOR

Whereas, I, Zhiyun Luo of 1473 Shaffer Drive

AND CITY

San Jose, California 95132

have invented:

TITLE:

SGT MOSFET WITH ADJUSTABLE CRSS AND CISS

DATE INVENTOR and executed a United States patent application therefor SIGNED THE

DECLARATION

on October 22, 2015;

Whereas, Hunteck Semiconductor (Shanghai), Ltd., a Chinese Company, having its registered address at 560 Shengxia Road Suit 902C-7, Shanghai, China 201210 (hereinafter called HUNTECK), desires to acquire the entire right, title and interest of said application and invention, and to any United States and foreign patents to be obtained therefor:

Now therefore, for a valuable consideration, receipt whereof is hereby acknowledged, I, the above named, hereby sell, assign, and transfer to HUNTECK, its successors and assigns, the entire right, title and interest in the said application and invention therein disclosed for the United States and foreign countries, and all rights of priority resulting from the filing said United States application, and I request the Commissioner of Patents to issue any Letters Patent granted upon the inventions set forth in said application to HUNTECK its successors and assigns; and I hereby agree that HUNTECK may apply for foreign Letters Patent on said invention and I will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by

CITY AND

Signed and Sealed at San Jose, California

DATE

on October 2, 2018.

SIGNATURE OF INVENTOR

PATENT REEL: 047457 FRAME: 0091

RECORDED: 11/08/2018